

BM54 Series

Small Floating Board-to-Board Connector, 125°C Heat Resistance, For Automotive Applications



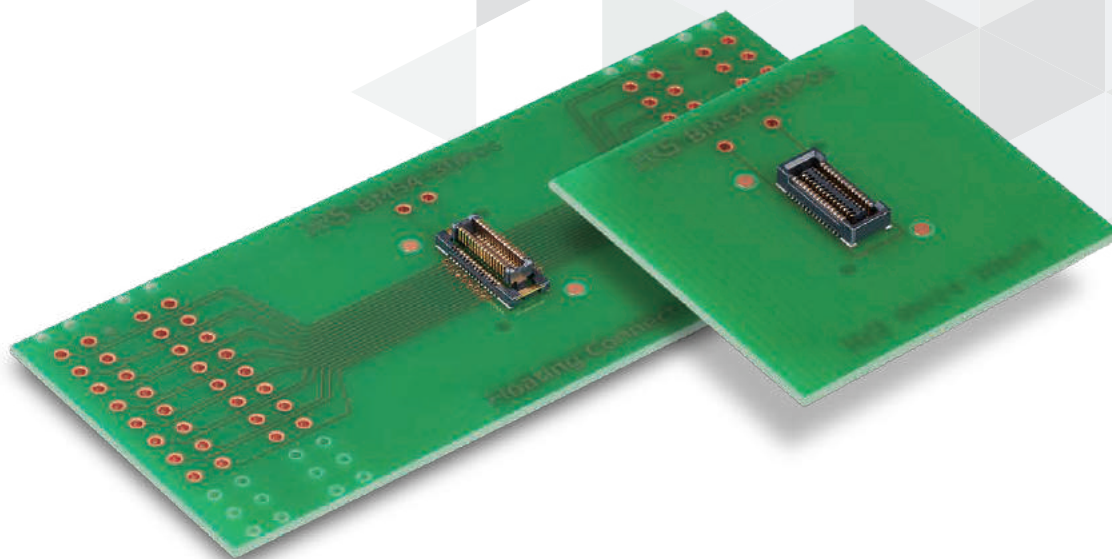
Compact



Floating



High Temp

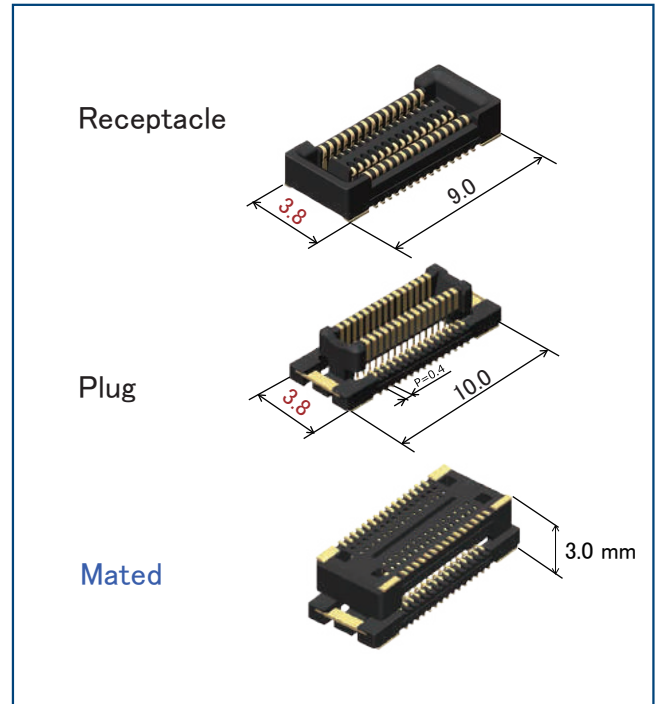


NEW

Features

1. Stacking Height 3.0 to 4.5mm, Floating Range ± 0.4 mm, World's Smallest Width Class in Floating Board-to-Board Connectors

0.4mm Pitch, 3.8mm Width, it contributes to making board design space-saving. Significantly reduces the area occupied on mounting part.



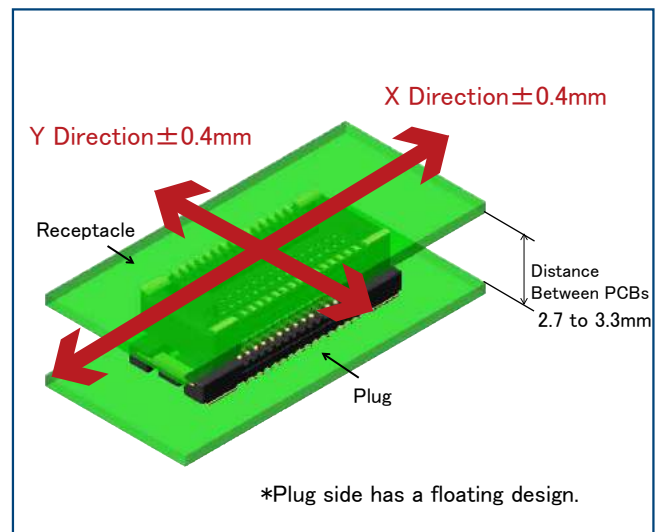
e.g. Stacking Height : 3.0mm, 30pos.

2. Absorption of Misalignment

X and Y Directions :
Floating Range ± 0.4 mm

Z Direction :
Effective Mating Length
 ± 0.3 mm (3.0mm Stacking Height)
 ± 0.4 mm (3.5, 4.0, 4.5mm Stacking Height)

The board mounting misalignment can be absorbed by the connector.

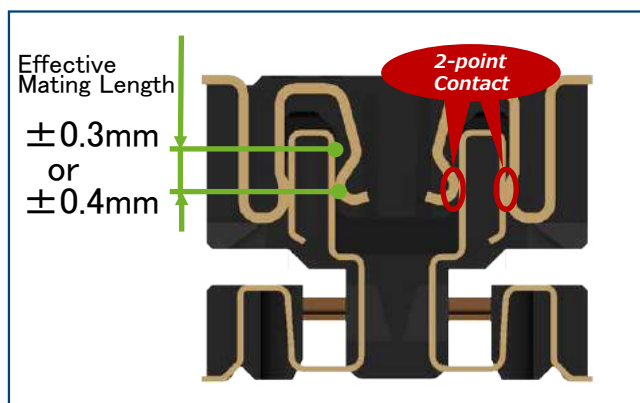


e.g. Stacking Height : 3.0mm

3. 125°C Heat Resistance for Automotive Specifications

4. High Contact Reliability with Two-Point Contact

Industry's First Two-Point Contact Design of Low-Profile Floating Board to Board Connector



5. Supports PCI-ex Gen4 (16Gbps) and MIPI D-PHY Ver.2.1

PCI-ex Gen4 (16Gbps)

- Pin Assign : GGGSSGSSGGG
- Reference Impedance : 85Ω

MIPI D-PHY Ver.2.1 (4.5Gbps)

- Pin Assign : GGSGSGSGSGG
- Reference Impedance : 100Ω

Applications

It can be used for in-vehicle applications for front cameras, Rear/Side Cameras, Millimeter-Wave Radar, LiDAR and other devices that require misalignment absorption of the substrate by small size floating.

It can also be used in devices that require absorption of the substrate misalignment for consumer and industrial equipment.

Product Specifications

| | | | |
|---------------|-----------|--|---------------|
| Rated Current | 0.3A | Operating Temperature (Note 1)(Note 2) | -55 to +125°C |
| Rated Voltage | 50V AC/DC | Storage Temperature (Note 3) | -10 to +60°C |

| Item | Standards | Condition |
|------------------------|--|--|
| Contact Resistance | Initial : 80m Ω Max. After the Test : 100m Ω Max. | Measured at 20mV AC, 1kHz, 1mA |
| Insulation Resistance | 100M Ω Min. | Measured at 100V DC |
| Withstanding Voltage | No flashover or dielectric breakdown | 100V AC rms for 1 min. |
| Mating Durability | Contact Resistance : 100 m Ω Max. No damage, cracks, or parts dislocation | 10 times |
| Vibration Resistance | No electrical discontinuity of 1 μ s or more | Frequency 10 to 500Hz, Acceleration 49m/s ² Swept speed 1oct/min 8 hours each of 3-axis direction |
| Heat Resistance | Contact Resistance : 100 m Ω Max. Insulation Resistance : 100M Ω Min. | Left for 1000 hours at temperature 125 ± 2°C |
| Humidity Resistance | Contact Resistance : 100 m Ω Max. Insulation Resistance : 50M Ω Min. | Temperature -10 → +65°C , RH In 90 to 96% Left for 10 cycles (240 hours) |
| Temperature Cycle | Contact Resistance : 100 m Ω Max. Insulation Resistance : 100M Ω Min. | Temperature -55°C : 30 min. → +125°C : 30 min., 1000 cycles (Tank transfer time : 2 to 3 min.) |
| Solder Heat Resistance | No deformation in appearance or significant damage to contacts | Reflow : See recommended temperature profile Manual soldering : 350°C within 3 seconds |

Note 1 : Includes the temperature rise due to current flow.
Note 2 : Use without condensation.
Note 3 : Storage refers to long-term storage of unused items before they are mounted on the PCB.
Operating temperature and humidity range apply when the product is not powered after PCB mounting and when temporarily stored during transportation.

Materials/Finish

| Component | Material | Color/Finish | Remarks |
|---------------|--------------|------------------------------------|---------|
| Insulator | LCP | Black | - |
| Contact | Copper Alloy | Gold Plating (nickle underplating) | - |
| Retention Tab | Copper Alloy | Gold Plating (nickle underplating) | - |

Product Number Structure

Please utilize the below part number chart when selecting.

■ 3.0mm Stacking Height

● Plug

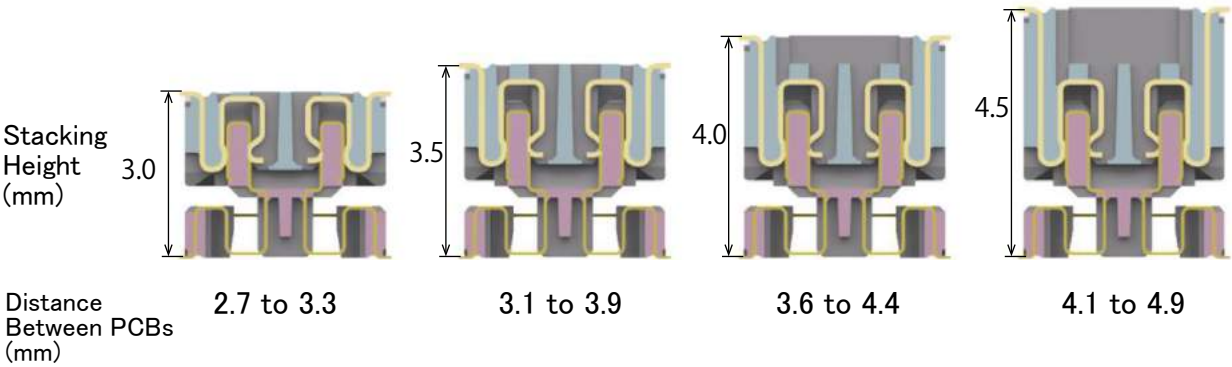
BM54 F 3.0 - ## DP - 0.4 V (##)
① ② ③ ④ ⑤ ⑥ ⑦

● Receptacle

BM54 B 3.0 - ## DS - 0.4 V (##)
① ② ③ ④ ⑤ ⑥ ⑦

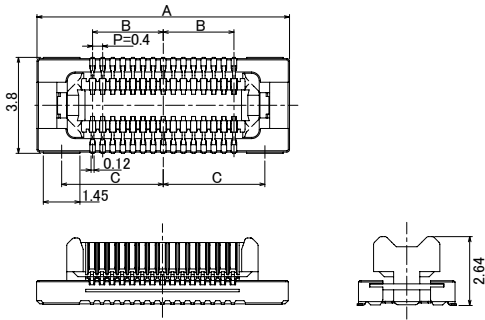
| | | | |
|-------------------|--|------------------|--|
| ① Series Name | BM54 | ⑤ Contact Pitch | 0.4mm |
| ② Stacking Height | 3.0 mm | ⑥ Contact Type | V : Straight SMT |
| ③ No. of Pos. | 20, 30, 40 | ⑦ Packaging Type | (51) : Embossed Packaging BM54F 3,000pcs/Reel BM54B 4,000pcs/Reel (53) : Embossed Packaging 500pcs/Reel (For trial production) |
| ④ Connector Type | DP : Double Row Plug DS : Double Row Receptacle | | |

Combinations

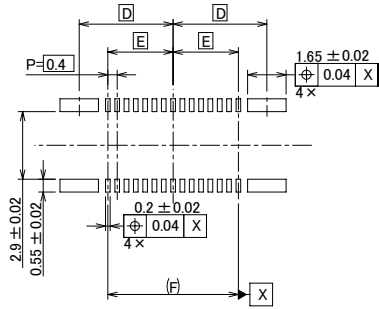


| | | |
|---------------------|--------------------|------------------|
| | Unit : mm | |
| Receptacle / Plug | BM54F3.0-##DP-0.4V | BM54MF-##DP-0.4V |
| BM54B3.0-##DS-0.4V | 3.0 | - |
| BM54MB3.5-##DS-0.4V | - | 3.5 |
| BM54MB4.0-##DS-0.4V | - | 4.0 |
| BM54MB4.5-##DS-0.4V | - | 4.5 |

BM54 Plug (3.0mm Stacking Height)



● **Recommended PCB Layout**

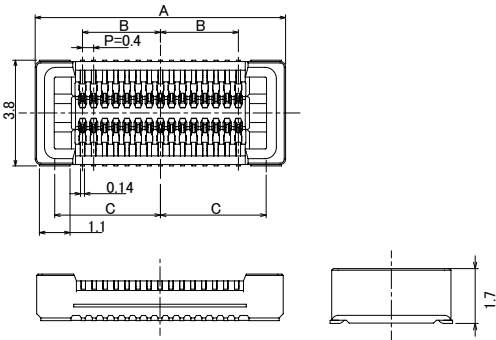
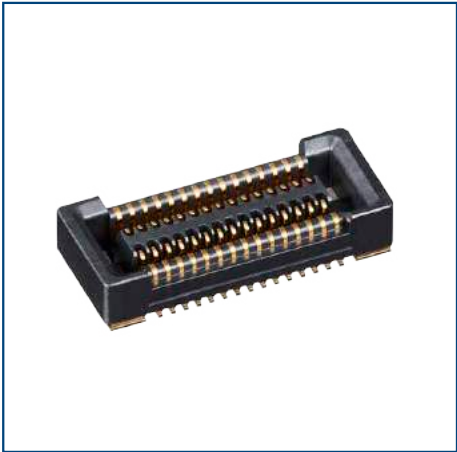


Unit : mm

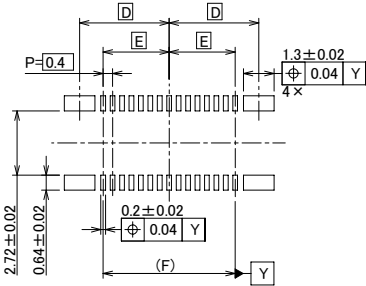
| Part No. | HRS No. | No. of Pos. | A | B | C | D | E | F | Purchase Unit (##) : (51) | Purchase Unit (##) : (53) |
|------------------------|------------------------|-------------|------|-----|-------|-------|-----|-----|---------------------------|---------------------------|
| BM54F3.0-20DP-0.4V(##) | Under Planning (Note1) | 20 | 8.0 | 1.8 | 3.025 | 3.025 | 1.8 | 3.6 | 3,000pcs per reel | 500pcs per reel |
| BM54F3.0-30DP-0.4V(##) | CL0684-4603-0-## | 30 | 10.0 | 2.8 | 4.025 | 4.025 | 2.8 | 5.6 | | |
| BM54F3.0-40DP-0.4V(##) | Under Planning (Note1) | 40 | 12.0 | 3.8 | 5.025 | 5.025 | 3.8 | 7.6 | | |

Note 1 : Contact positions without HRS No. are currently under planning.
Please contact a Hirose representative regarding questions on pin count variation development.
Note 2 : This connector has no polarity.

BM54 Receptacle (3.0mm Stacking Height)



● Recommended PCB Layout



Unit : mm

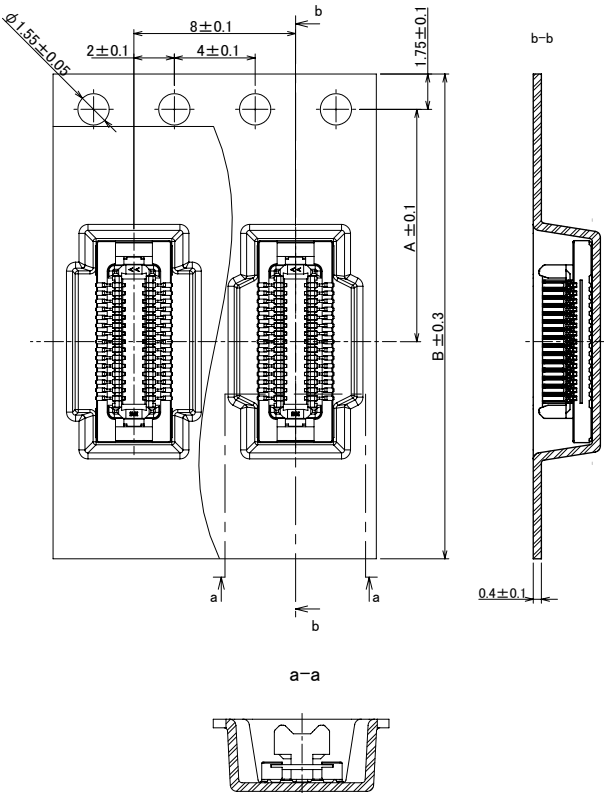
| Part No. | HRS No. | No. of Pos. | A | B | C | D | E | F | Purchase Unit (##) : (51) | Purchase Unit (##) : (53) |
|------------------------|------------------------|-------------|------|-----|-----|-----|-----|-----|------------------------------|------------------------------|
| BM54B3.0-20DS-0.4V(##) | Under Planning (Note1) | 20 | 7.0 | 1.8 | 2.8 | 2.8 | 1.8 | 3.6 | 4,000pcs per reel | 500pcs per reel |
| BM54B3.0-30DS-0.4V(##) | CL0684-4602-0-## | 30 | 9.0 | 2.8 | 3.8 | 3.8 | 2.8 | 5.6 | | |
| BM54B3.0-40DS-0.4V(##) | Under Planning (Note1) | 40 | 11.0 | 3.8 | 4.8 | 4.8 | 3.8 | 7.6 | | |

Note 1 : Contact positions without HRS No. are currently under planning.
Please contact a Hirose representative regarding questions on pin count variation development.
Note 2 : This connector has no polarity.

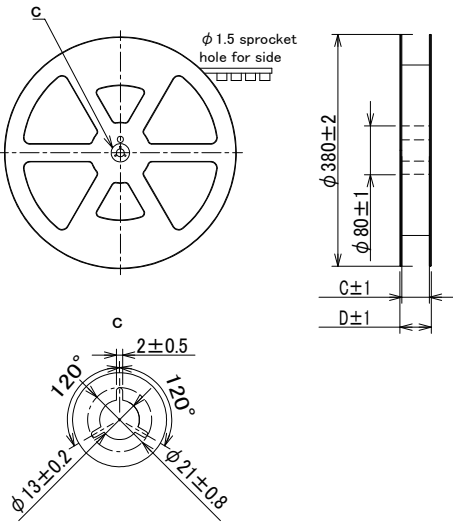
Packaging Specifications Diagram (JIS C 0806, IEC 60286-3 Compliant)

■BM54 Plug (3.0mm Stacking Height)

●Embossed Tape Dimensions



●Reel Dimensions



Unit : mm

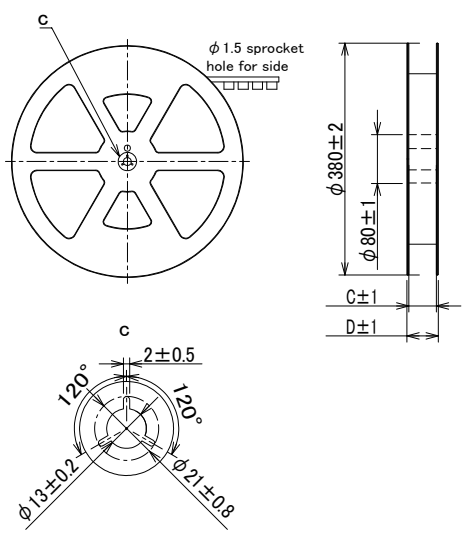
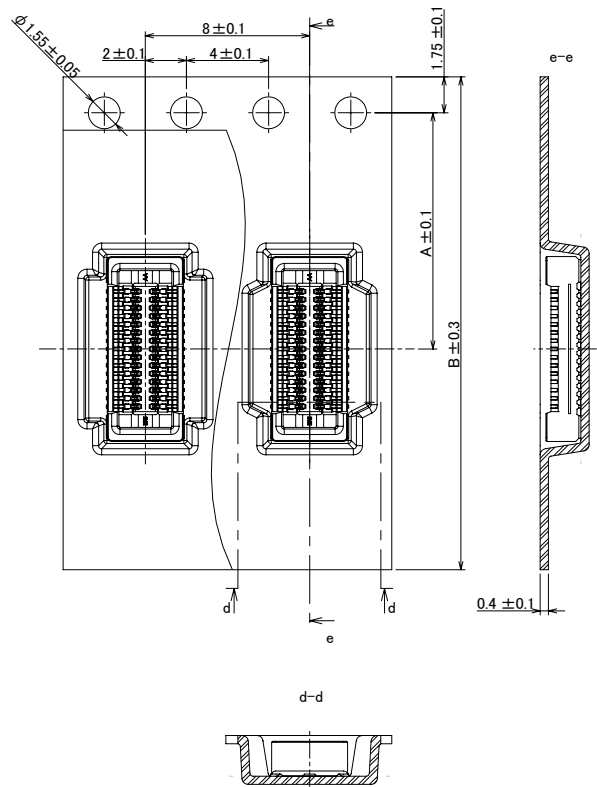
| Part No. | HRS No. | A | B | C | D | Purchase Unit (##) : (51) | Purchase Unit (##) : (53) |
|------------------------|-----------------------|------|------|------|------|------------------------------|------------------------------|
| BM54F3.0-20DP-0.4V(##) | Under Planning (Note) | 11.5 | 24.0 | 25.4 | 31.4 | 3,000pcs per reel | 500pcs per reel |
| BM54F3.0-30DP-0.4V(##) | CL0684-4603-0-## | | | | | | |
| BM54F3.0-40DP-0.4V(##) | Under Planning (Note) | | | | | | |

Note : Contact positions without HRS No. are currently under planning.
Please contact a Hirose representative regarding questions on pin count variation development.

■BM54 Receptacle (3.0mm Stacking Height)

●Embossed Tape Dimensions

●Reel Dimensions

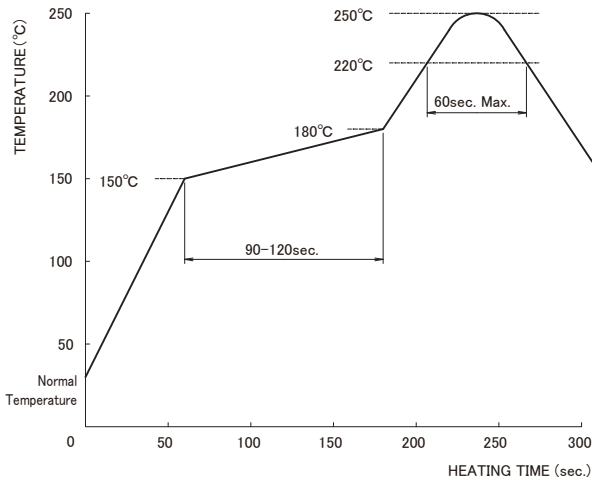


Unit : mm

| Part No. | HRS No. | A | B | C | D | Purchase Unit (##) : (51) | Purchase Unit (##) : (53) |
|------------------------|-----------------------|------|------|------|------|------------------------------|------------------------------|
| BM54B3.0-20DS-0.4V(##) | Under Planning (Note) | 11.5 | 24.0 | 25.4 | 31.4 | 4,000pcs per reel | 500pcs per reel |
| BM54B3.0-30DS-0.4V(##) | CL0684-4602-0-## | | | | | | |
| BM54B3.0-40DS-0.4V(##) | Under Planning (Note) | | | | | | |

Note : Contact positions without HRS No. are currently under planning.
Please contact a Hirose representative regarding questions on pin count variation development.

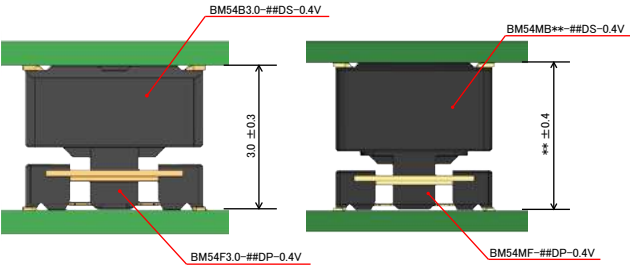
Precautions

| | |
|--|--|
| Recommended Temperature Profile |  <p>【Conditions】</p> <ol style="list-style-type: none"> 1. Peak Temperature : 250°C 2. Heating : 220°C Min. for 60 sec. Max. 3. Preheating : 150 to 180°C, 90 to 120 sec. 4. Number of Reflow Cycles : 2 cycles Max. <p>* Temperature refers to the surface temperature of the board near the connector lead. We recommend reflow mounting in a nitrogen environment.</p> |
| Recommended Manual Soldering Conditions | Soldering iron temperature : $340 \pm 10^{\circ}\text{C}$, Soldering Time : Within 3 sec. |
| Recommended Metal Mask Thickness and Open Area to PCB Pattern (Area Ratio) | Thickness : 0.1mm, Aperture Ratio : DS 80% DP 90% |
| Board Warpage | Max. of 0.02mm at the center in reference to both ends of the connector |
| Cleaning | Cleaning is not recommended. If you clean this product, please evaluate its performance before using it. (Cleaning may impair the mating/unmating properties and lower resistance to environmental factors.) |
| Precautions | <ul style="list-style-type: none"> • Be careful when mating/unmating the connector when it is not mounted on the PCB as it may cause damage/deformation to contacts. • Avoid supporting the PCB only with the connectors. Support it by other means such as bolts, screws, posts, etc. • Excessive prying during unmating/mating may result in damage. • In the case of hand soldering, please do not apply any flux which could cause flux wicking. • This product may have slight color differences due to production lot variability, but this does not affect the performance. • Please refer to the following page for handling precautions when inserting and removing. • Because the product can disengage if dropped (or other impact), or by FPC routing, it is advised to secure the mated connectors to the board with housings and cushioning materials. • Do not use the connector in non-recommended conditions (i.e., rated current, rated voltage, PCB design and operating environment, etc.). Such usage could lead to material outgassing, ignition, or short-circuit, etc. Refer to the specifications and guidelines for board pattern dimensions, board cautions, and connector treatment. Please contact Hirose if connector usage in conditions other than those described in the specifications and the guidelines is being considered. |

Precautions for Handling During Use

●About Setting The Distance Between PCBs

Use within the specified dimensions between PCBs below.

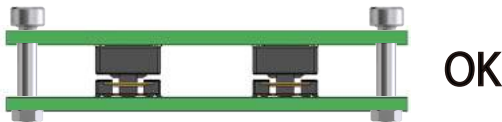


| Stacking Height | Specified Dimensions Between PCBs | Plug | Receptacle |
|-----------------|-----------------------------------|--------------------|---------------------|
| 3.0mm | 2.7 to 3.3mm | BM54F3.0-##DP-0.4V | BM54B3.0-##DS-0.4V |
| 3.5mm | 3.1 to 3.9mm | BM54MF-##DP-0.4V | BM54MB3.5-##DS-0.4V |
| 4.0mm | 3.6 to 4.4mm | | BM54MB4.0-##DS-0.4V |
| 4.5mm | 4.1 to 4.9mm | | BM54MB4.5-##DS-0.4V |

●Securing PCBs

This connector can absorb misalignment between PCBs, but not vibration.
If you support PCBs only with the connectors without taking any fixing measures, the load on the connectors will be excessive and may cause broken or contact failure.
Be sure to secure PCBs except for the connectors as shown below to prevent the board from moving.
This connector connects the board to the board.
When using mounting to FPC, fasten the board and FPC to the case separately.

Fixing PCBs with a Spacer or Case



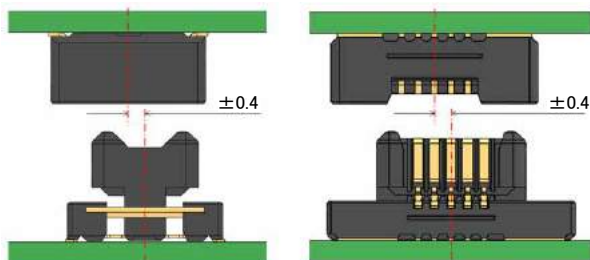
Do not use the product without fixing PCBs together.



●Mating Precautions

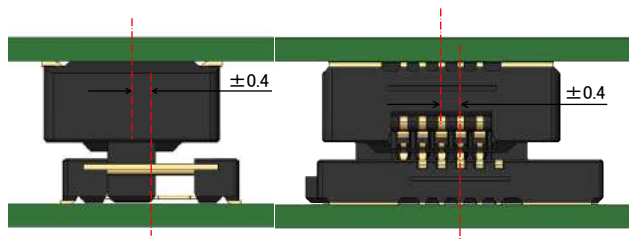
1. Mating

The alignment dimension is ± 0.4 mm in the X and Y directions.
After the start of mating, follow the alignment and mate perpendicularly to the board without applying an overloading to the connector.



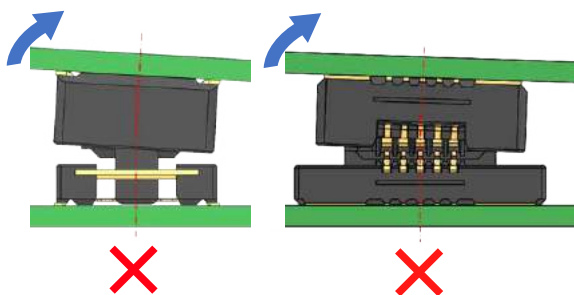
2. Misalignment Allowance in Mated Condition (Floating Range)

Because of floating design, this connector has a ± 0.4 mm board misalignment tolerance in the X and Y directions when mated. However, it is not suitable for absorption when the range of misalignment constantly changes due to vibration, etc. The number of repetitions of floating movable operations is stipulated to be no more than 10 times.



3. Removing

When removing the connector, pull it out in parallel.
If it is removed in an inclined position, connector may deform.



While Taking into Consideration

Specifications mentioned in this catalog are reference values.

When considering to order or use this product, please review the Drawing and Product Specifications sheets.

Use an appropriate cable when using the connector in combination with cables.

If considering usage of a non-specified cable, please contact your sales representative.

If assembly process is done by jigs & tools which are not identified by Hirose, the warranty of the product may be affected.

If considering usage for below mentioned applications, please contact your sales representative.

In cases where the application will demand a high level of reliability, such as automotive, medical instruments, public infrastructure, aerospace/defense etc. Hirose must review before assurance of reliability can be given.

HIROSE



HIROSE ELECTRIC CO.,LTD.

2-6-3 Nakagawa Chuoh, Tsuzuki-Ku, Yokohama-Shi 224-8540, JAPAN
<https://www.hirose.com>